

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

### **Product image**



















The inverted BCL-SMT socket block for the PCB offers three significant advantages:

- The BCL-SMT offers touch-safe security on the PCB which makes it ideal for live, current-carrying outputs.
- The BCL-SMT widens the range of applications with board-to-board connections between component as-
- The BCL-SMT is reflow-compatible and can be seamlessly integrated into the automatic assembly and soldering process.

Two outlet directions give you a choice of position and thus more design flexibility.

- 180° standing
- 90° recumbent

Two housing variants are available for the BCL-SMT:

- Without flange
- With inverted solder flange ("LFI", with nut)
- • Fastened to PCB without additional screw
  - · Fastened with screw to the SCZ FI

Weidmüller's 3.81-mm-pitch (0.15 inch) plug-in connectors are compatible with the layouts of customary connectors and offer space for labelling and coding.

### General ordering data

Version	PCB plug-in connector, female header, closed side, THT/THR solder connection, 3.81 mm, Number of
	poles: 2, 90°, Solder pin length (I): 1.5 mm, tinned,
	black, Tape
Order No.	<u>1991660000</u>
Туре	BCL-SMT 3.81/02/90 1.5SN BK RL
GTIN (EAN)	4050118376234
Qty.	390 pc(s).
Product data	IEC: 320 V / 17.5 A
	UL: 300 V / 10 A
Packaging	Tape



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# **Technical data**

-			
Dim	ensions	and	weights

Net weight	1.02 g

## **System specifications**

Product family	OMNIMATE Signal - series	Type of connection	
,	BC/SC 3.81		Board connection
Mounting onto the PCB	THT/THR solder connec-	Pitch in mm (P)	
	tion		3.81 mm
Pitch in inches (P)	0.15 "	Outgoing elbow	90°
Number of poles	2	Number of solder pins per pole	2
Solder pin length (I)	1.5 mm	Solder pin length tolerance	0 / -0,02 mm
Solder pin dimensions	d = 0.8 mm	Solder pin dimensions = d tolerance	+0,05 / -0,05 mm
Solder eyelet hole diameter (D)	1.2 mm	Solder eyelet hole diameter tolerance (I	O)+ 0,1 mm
Outside diameter of solder pad	1.9 mm	Template aperture diameter	1.6 mm
L1 in mm	3.81 mm	L1 in inches	0.15 "
Pin series quantity		Touch-safe protection acc. to DIN VDE	Safe from back-of-hand
	1	57 106	touch
Touch-safe protection acc. to DIN VDE		Volume resistance	
0470	IP20 plugged		≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	9.5 N
Pulling force/pole, max.	6 N		

### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-25 ℃
Temperature range, installation, max.	120 °C		

### Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	17.5 A
Rated current, max. number of poles (Tu=20°C)	15.4 A	Rated current, min. number of poles (Tu=40°C)	17.5 A
Rated current, max. number of poles (Tu=40°C)	13.7 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 76 A

## Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group C / CSA)	50 V
Rated current (Use group B / CSA)	11 A	Rated current (Use group C / CSA)	11 A



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## **Technical data**

#### Rated data acc. to UL 1059

Rated voltage (Use group B / UL 1059) 300 V	Rated voltage (Use group D / UL 1059) 300 V
Rated current (Use group B / UL 1059) 10 A	Rated current (Use group D / UL 1059) 10 A

### **Packing**

ESD Level packaging	static dissipative	Packaging	Tape
VPE length	336 mm	VPE width	333 mm
VPE height	35 mm	Tape depth (T2)	9 mm
Tape width (W)	24 mm	Tape pocket depth (KO)	8.6 mm
Tape pocket height (A0)	14.8 mm	Tape pocket width (B0)	16.4 mm
Tape pocket separation (P1)	20 mm	Tape hole separation (E)	1.75 mm
Tape pocket separation (F)	11.5 mm	Tape reel diameter Ø (A)	330 mm
Surface resistance	$Rs = 10^9 - 10^{12} \Omega$		

### Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ETIM 10.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01
ECLASS 13.0	27-46-02-01	ECLASS 14.0	27-46-02-01
ECLASS 15.0	27-46-02-01		

### **Environmental Product Compliance**

RoHS Compliance Status	Compliant without exemption
REACH SVHC	No SVHC above 0.1 wt%

### Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized stan- dards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Rated current related to rated cross-section & min. No. of poles.
	• P on drawing = pitch

- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load
- Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

### **Approvals**

ROHS Conform		
	ROHS	



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# **Technical data**

### **Downloads**

Engineering Data	CAD data – STEP
Product Change Notification	Changeover to ESD bags for "Tape on Reel" products
	Umstellung auf ESD-Beutel bei "Tape on Reel" Produkten
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN
	<u>FL DRIVES DE</u>
White paper surface mount technology	Download Whitepaper



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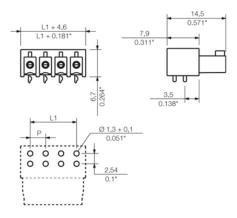
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## **Drawings**

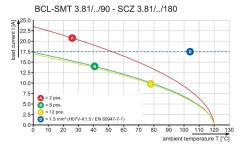
## **Product image**



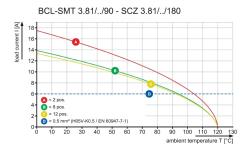
## **Dimensional drawing**



### Graph



### Graph





## Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

## Single Wave:



#### **Double Wave:**



## Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



## Recommended reflow soldering profile

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## **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.